Low Capacitance Quad Array for ESD Protection

This integrated transient voltage suppressor device (TVS) is designed for applications requiring transient overvoltage protection. It is intended for use in sensitive equipment such as computers, printers, business machines, communication systems, medical equipment, and other applications. Its integrated design provides very effective and reliable protection for four separate lines using only one package. This device is ideal for situations where board space is at a premium.

Features

• ESD Protection: IEC61000-4-2: Level 4

MILSTD 883C - Method 3015-6: Class 3

- Four Separate Unidirectional Configurations for Protection
- Low Leakage Current < $1 \mu A$
- Power Dissipation: 380 mW
- Small SC-88A SMT Package
- Low Capacitance
- This is a Pb–Free Device

Benefits

- Provides Protection for ESD Industry Standards: IEC 61000, HBM
- Minimize Power Consumption of the System
- Minimize PCB Board Space

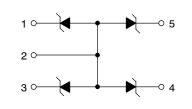
Typical Applications

- Instrumentation Equipment
- Serial and Parallel Ports
- Microprocessor Based Equipment
- Notebooks, Desktops, Servers
- Cellular and Portable Equipment



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SC-88A/SOT-323 CASE 419A

MARKING DIAGRAM



RY = Specific Device Code

M = Date Code

= Pb-Free Package

ORDERING INFORMATION

Device	Package	Shipping [†]
NUP4108W5T2G	SC-88A (Pb-Free)	3000/Tape & Reel

⁺For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MAXIMUM RATINGS ($T_A = 25^{\circ}C$ unless otherwise noted)

Rating	Symbol	Value	Unit
Peak Power Dissipation $8 \times 20 \ \mu sec$ Double Exponential Waveform (Note 1)	P _{PK}	20	W
Steady State Power – 1 Diode (Note 2)	PD	380	mW
Thermal Resistance – Junction-to-Ambient Above 25°C, Derate	R _{θJA}	327 3.05	°C/W mW/°C
Operating Junction Temperature Range	TJ	-40 to +125	°C
Storage Temperature Range	T _{stg}	–55 to +150	°C
Lead Solder Temperature – Maximum 10 Seconds Duration	ΤL	260	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

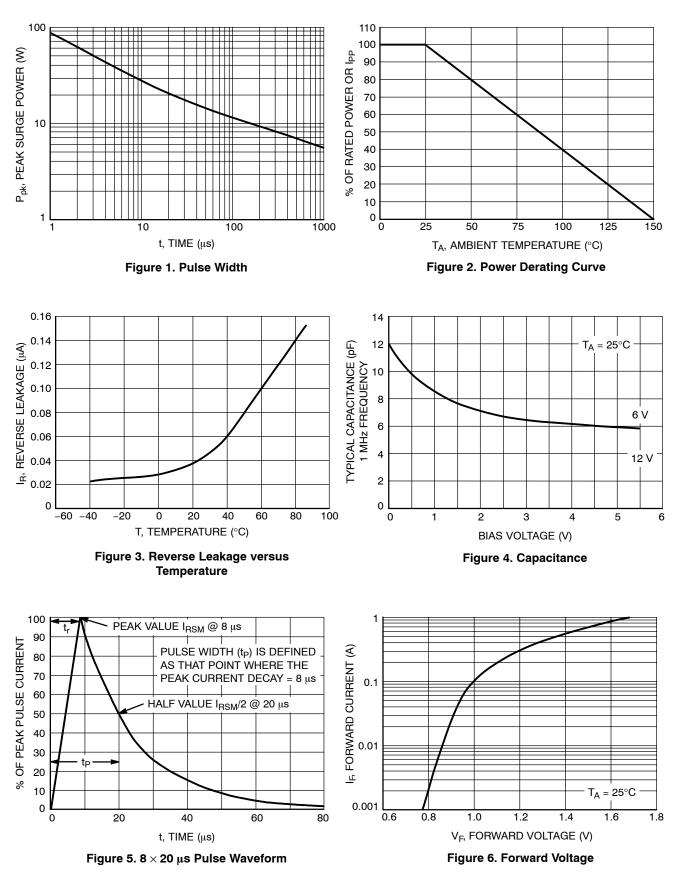
Non-repetitive current pulse per Figure 1.
Only 1 diode under power. For all 4 diodes under power, P_D will be 25%. Mounted on FR4 board with min pad.

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

NUP4108W5

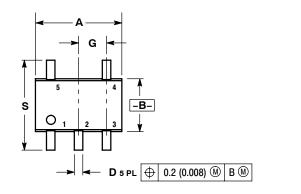
Characteristic	Symbol	Min	Тур	Мах	Unit
Breakdown Voltage (I _T = 1 mA) (Note 3)		6.4	6.8	7.1	V
Leakage Current (V _{RWM} = 5.0 V)		-	-	1.0	μA
Clamping Voltage 1 (I _{PP} = 1.6 A, 8 \times 20 µsec Waveform)		-	-	13	V
Maximum Peak Pulse Current (8 \times 20 μsec Waveform)		-	-	1.6	А
Junction Capacitance – (V _R = 0 V, f = 1 MHz) – (V _R = 3.0 V, f = 1 MHz)			12 6.7	15 9.5	pF

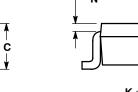
3. V_{BR} is measured at pulse test current I_{T}



PACKAGE DIMENSIONS

SC-88A, SOT-353, SC-70 CASE 419A-02 ISSUE J





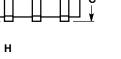
NOTES: 1. DIMENSIONING AND TOLERANCING

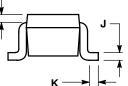
PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

 419A–01 OBSOLETE. NEW STANDARD 419A–02.

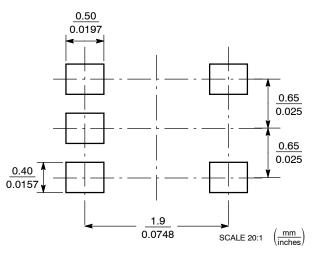
 4. DIMENSIONS A AND B DO NOT INCLUDE
MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

	INC	HES	MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.071	0.087	1.80	2.20	
В	0.045	0.053	1.15	1.35	
С	0.031	0.043	0.80	1.10	
D	0.004	0.012	0.10	0.30	
G	0.026 BSC		0.65 BSC		
н		0.004		0.10	
J	0.004	0.010	0.10	0.25	
K	0.004	0.012	0.10	0.30	
N	0.008 REF		0.20 REF		
S	0.079	0.087	2.00	2.20	





SOLDERING FOOTPRINT*



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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